

## 12500 TI Boulevard, MS 8640, Dallas, Texas 75243

# Notification# 20161011000 Datasheet for SN74LVC244A Information Only

**Date:** October 12, 2016

To: TOKYO ELECTRON DEVICE (DSTR) PCN

#### Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN www admin team@list.ti.com).

Sincerely,

PCN Team SC Business Services

# Information Only Attachments

## **Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	<b>CUSTOMER PART NUMBER</b>
SN74LVC244ADBR	null
SN74LVC244APW	null
SN74LVC244APWR	null
SN74LVC244ARGYR	null
SN74LVC244ANSR	null
SN74LVC244AZQNR	null
SN74LVC244ADWG4	null
SN74LVC244APWT	null
SN74LVC244APWRG3	null
SN74LVC244APWRG4	null

Technical details of this Product Change follow on the next page(s).

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SN74LVC244ADWE4 SN74LVC244ANSRE4	SN74LVC244APWT	
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For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com